Fundamentals and Applications of High-pressure Induction Thermal Plasmas with Coil Current Modulation

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Abstract: This paper presents a summary of fundamental principles and applications of modulated induction thermal plasmas that have been developed by the author’s group. The modulated induction thermal plasma is established using a coil current that is modulated to the order of several hundreds of amperes at a millisecond time scale. Such a large current modulation enables the creation of a large disturbance in high-pressure and high-temperature plasmas. It also enables control of the temperature and radical density in thermal plasmas in a time domain. Examples are described for application of the modulated induction thermal plasma to surface modification. Thermally and chemically non-equilibrium effects are essential in temperature and radical density fields. The latest result is also presented for various applications of modulated induction thermal plasmas. Finally, dynamic behaviors of a recently developed arbitrary-waveform modulated induction thermal plasma are also introduced as a new type of modulated induction thermal plasma.

1. INTRODUCTION

Inductively coupled thermal plasma (ICTP) is widely used for various material processes such as synthesis of nanopowders, thermal barrier coatings, diamond film deposition, surface modification, etc. [1-9]. Advantages of using thermal plasma include its much higher densities of reactive species or radicals, and high gas temperatures. However, gas temperatures in thermal plasmas are sometimes too high and are difficult to control. To control gas temperatures and densities of reactive atoms/molecules in thermal plasmas, we developed a system of several tens of kilowatt-class pulse-modulated induction thermal plasma (PMITP) [10-17]. This system can modulate the amplitude of the coil current, allowing induction thermal plasmas to be sustained by a rectangular modulation waveform that is altered on a millisecond time scale. The millisecond rectangular modulation in the coil current perturbs the temperature of thermal plasmas remarkably. It can markedly change densities of atoms and molecules in thermal plasmas. Through this periodical perturbation of the thermal plasmas, we can then control their time-averaged value in the time domain [16, 17]. This modulation also provides non-equilibrium effects even in high-pressure thermal plasmas. On the other hand, some studies have investigated application of the PMITP to materials processing [18-23]. For example, Ohashi et al. applied the Ar-H2 PMITP for hydrogen doping to ZnO. Their results show that H atoms can be implanted into ZnO by treatment with an Ar-H2 PMITP, thereby improving its photoluminescence [19, 20]. We have also investigated application of the Ar-N2 PMITP for surface nitridation processing of materials [21-23].

As described herein, the author presents fundamental principles and applications of modulated induction thermal plasmas that have been developed by the author’s group. First, the system of pulse-modulated induction thermal plasmas is described. Secondly, fundamental dynamic behaviors of PMITP obtained mainly through our experiments are introduced. Experimental results indicate that the millisecond rectangular modulation in the coil current provides a large disturbance in the radiation intensity of the Ar line and also that the modulation can change the Ar excitation temperature from 5000 to 10 000 K, especially in Ar-CO2 PMITP [16]. Thirdly, an example is presented in applications of modulated induction thermal plasmas for high-speed surface nitridation processing. Results of this work show that the rectangular modulation of the coil current can provide an increased number of excited N atoms; simultaneously, the decreased enthalpy flow onto a specimen irradiated by Ar-N2 PMITP. Both the nitrogen atomic density and the enthalpy flow are crucial for nitridation processing using thermal plasmas. On the other hand, our non-equilibrium calculations imply that the above simultaneous control of the increased nitrogen atomic density and the decreased enthalpy flow are attributable to chemically non-equilibrium effects [24-26]. Some other applications of PMITP to surface modification will be introduced briefly [18-20]. Fourthly, the latest results on application of Ar-O2 PMITP are presented for nanopowder synthesis. Finally, modulated induction thermal plasmas of a new type, i.e. the arbitrary waveform modulated induction thermal plasma (AMITP) are introduced. The time evolution in Ar excitation temperature in Ar AMITP is described [27]. This system can modulate the amplitude of the coil current to follow a control signal formed not only in a rectangular waveform, but also an externally given arbitrary waveform. Such a modulation of the coil current supports the detailed control of temperature of thermal plasmas.
2. CHARACTERISTIC TIMES IN THERMAL PLASMAS

It is important to understand characteristic times for changing the state in thermal plasmas. We consider characteristic times in centimeter-class Ar thermal plasmas around 5000 K at atmospheric pressure. Typical characteristic times for thermal conduction, diffusion and convection were estimated using the following simple equations

\[ t_{\text{cond}} = \frac{\rho C_v L^2}{\lambda} \]  
(1)

\[ t_{\text{diff}} = \frac{L^2}{D} \]  
(2)

\[ t_{\text{conv}} = \frac{L}{u} \]  
(3)

\[ t_{\text{reac}} = \frac{1}{\alpha n} \]  
(4)

where \( t_{\text{cond}} \), \( t_{\text{diff}} \), \( t_{\text{conv}} \), and \( t_{\text{reac}} \) are, respectively, the characteristic times for thermal conduction, diffusion, convection and reactions, \( L \) is the characteristic length, \( \rho \) is the mass density, \( C_v \) is the specific heat, \( \lambda \) is the thermal conductivity, \( D \) is the diffusion coefficient, \( u \) is the gas velocity, \( \alpha \) is the reaction rate, and \( n \) is the number density of the plasma. In this estimation, \( u \) of 10-100 m/s was used for induction of thermal plasmas [26].

According to Table 1, thermal conduction, diffusion and convection have characteristic times of several milliseconds. Reactions have a wide time range because reactions of various types including ionization, recombination and excitation are present in thermal plasmas. On the other hand, the radio-frequency (rf) cycle time of the coil current is about \( 10^{-7} \text{ to } 10^{-5} \) s because the frequency of 0.1-10 MHz is usually adopted for the coil current sustaining high-pressure thermal plasmas. This rf cycle time is much shorter than the above characteristic times except reactions, which means that plasma is statically established with no macroscopic disturbance by such an rf coil current. The modulation cycle time used for modulated thermal plasmas is on the order of milliseconds. This modulation cycle in milliseconds has a similar order to that of the characteristic times in thermal plasmas. Therefore, such a millisecond modulation of the coil current can markedly perturb even the heavy-particle temperature and gas flow fields and reaction fields. Furthermore, controlling the modulation amplitude of the coil current and the modulation waveform enables us to control the temperature and gas flow fields in a time domain.

### Table 1. Characteristic Times in Centimeter-class Thermal Plasmas at 5000 K at Atmospheric Pressure

<table>
<thead>
<tr>
<th>Phenomena</th>
<th>Characteristic Time</th>
</tr>
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<tbody>
<tr>
<td>Thermal conduction</td>
<td>( 10^{-7} \text{ to } 10^{-5} ) s</td>
</tr>
<tr>
<td>Diffusion</td>
<td>( 10^{-4} \text{ to } 10^{-3} ) s</td>
</tr>
<tr>
<td>Convection</td>
<td>( 10^{-5} \text{ to } 10^{-3} ) s</td>
</tr>
<tr>
<td>Reactions</td>
<td>( 10^{-2} \text{ to } 10^{-3} ) s</td>
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3. FUNDAMENTAL PRINCIPLES OF PULSE-MODULATED INDUCTION THERMAL PLASMAS (PMITP)

3.1. Concept of Modulated Thermal Plasmas

Fig. (1) shows the concept of modulated induction thermal plasmas [28, 29]. We can see two stable operation of plasmas; cold plasma mode and thermal plasma mode. The cold plasma has a relatively high electron temperature around several eV and a low gas temperature around \( \sim 0.03 \) eV at the same time. The cold plasma is in general sustained at lower pressure although the high pressure non-equilibrium plasma is also paid attention recently. On the other hand, thermal plasmas are established at high pressure and high power density. The thermal plasma, has the electron temperature generally close to the gas temperature around \( \sim 1.0 \) eV, and the much high density of radicals. Both the cold plasma and the thermal plasma can be sustained stably, and both can transit to another mode each other. There is a transition phase between these modes which is unstable for sustaining plasmas.

![Fig. (1). Concept of pulsation in cold or thermal plasmas.](image)

The pulsing technique was firstly used and has been well utilized for the low-temperature cold plasmas. In this case, the inputted energy or the applied voltage to the cold plasma is rapidly increased to raise the electron temperature and then the radical density, but is rapidly decreased to prevent the cold plasma from arcing or thermal breakdown. On the other hand, the pulsation for thermal plasmas gives control of gas temperature and radical density. The pulsation of the thermal plasma is expected to keep high radical density and to decrease lower gas temperature by utilizing non-equilibrium effects in the transition phase, escaping from the extinction of thermal plasmas.

3.2. Modulation of Coil Current for PMITP

For sustaining the pulse modulated induction thermal plasma (PMITP), the coil current modulated in a rectangular waveform shown in Fig. (2) was actually used. For the modulated coil current, the following modulation parameters are defined: the higher current level (HCL) is the higher amplitude of the coil current, the lower current level (LCL) is the lower amplitude of the coil current, the ‘on-time’ is the time duration with HCL in a modulation cycle, and the ‘off-time’ is the time duration with LCL in a modulation cycle. In addition, the shimmer current level (SCL) is also defined as
a ratio of LCL/HCL, and the duty factor (DF) is the ratio of ‘on-time’/(‘on-time’+’off-time’).

This modulation of the coil current in milliseconds markedly perturbs thermal plasmas; then the heavy particle temperature of plasmas changes periodically, as described in the previous section. Setting several modulation parameters makes it possible to control the time-averaged temperature of thermal plasmas.

3.3. Electric Circuit and Plasma Torch

To realize a PMITP system, we used a high-power semiconductor inverter power supply. Fig. (3) depicts the electric circuit of a power supply for PMITP. The system mainly contains four components: a rectifier circuit, an inverter circuit, an impedance-matching circuit and an ICP torch. Details of this power supply are available in [16, 17]. The coil current amplitude is modulated by intentionally controlling the fire angle of MOSFET elements to shift from the impedance matching point.

Fig. (3). Electric circuit for PMITP [16, 17].

Fig. (4) presents the configuration of a plasma torch for PMITP. The plasma torch comprises two coaxial quartz tubes with 330 mm length. The inner tube has 70 mm internal diameter. Between these two tubes, cooling water flows to maintain the temperature of the tube wall as 300 K. This plasma torch has an eight-turn induction coil around the quartz tube. Downstream of the plasma torch, a water-cooled reaction chamber is installed. Argon and other gas mixtures are supplied as a sheath gas along the inside wall of the inside quartz tube. The dynamic behavior of thermal plasma depends on the configuration and the scale of a plasma torch.

Fig. (4). Schematic diagram of plasma torch.

3.4. Stable Operation Region of PMITP

The time-averaged input power to the plasma decreases with reducing LCL or with increasing off-time if the HCL and on-time are fixed during PMITP operation. Decreasing the input power makes it difficult to sustain the PMITP. Therefore, the stable operation region is limited for the PMITP. Fig. (5) shows the critical boundary of the stable operation region for the PMITP as functions of the SCL and the duty factor DF at atmospheric pressure. This region was measured by changing LCL and off-time with a fixed HCL and a fixed on-time. The HCL was fixed at the value when the input power was 30 kW for non-modulation operation. The admixture rate of an additional molecular gas to Ar was set to 2.5 mol% if the molecular gas is added. The on-time was fixed at 10 ms. As portrayed in Fig. (5), the stable operation region is wide for an Ar PMITP; instability occurs at SCL<50% and DF<14%. This stable operation region becomes small for Ar PMITP with an additional molecular gas. Especially, Ar PMITP with CO₂ has the smallest stable operation region compared to other molecular gases such as H₂O₂ and N₂. For that reason, PMITP is useful for studying the plasma quenching efficiency of molecular gases, which is useful, for example, for circuit-breaker fields.

Fig. (5). Stable operation region for different PMITP [16].

3.5. Dynamic Behaviors of PMITP

3.5.1. Response of PMITP

Fundamental dynamic behavior is a basic datum that is useful to elucidate the nature of PMITP. Fig. (6) (a) portrays the pulse control signal; (b) shows the coil current amplitude for Ar PMITP; (c) shows the coil current amplitude for Ar-N₂ PMITP; and (d) shows the coil current amplitude for Ar-CO₂ PMITP [16, 17]. The shimmer current level (SCL=LCL/HCL) is taken as a parameter. The additional gas
admixture ratio is 2.5 mol% for N₂ and CO₂. For any gas mixture case, the coil current amplitude can be changed in 80 μs during its rapid increase and its rapid decrease. As seen in this figure, the electric current amplitude depends on the gas composition because the gas composition changes plasma conductance and thus the plasma impedance. Consequently, the inherent characteristic times of thermal plasmas with different gas mixtures can be estimated using this PMITP system, because the inherent characteristic times are much longer than the time shown above for rapid increase in the current amplitude.

Fig. (6). Coil current waveform for different PMITPs [16, 17].

Next, some examples of dynamic behaviors of Ar PMITP with or without molecular gases are presented. Fig. (7) portrays the time evolution in radiation intensity of Ar atomic line at 751 nm for different SCL [16, 17]. The input power is 30 kW for 100%SCL, i.e. for non-modulation operation, and the pressure is atmospheric pressure in the torch. The Ar gas flow rate is 100 slpm; the additional gas flow rate is 2.5 slpm. The radiation intensity of the Ar line was measured at 10 mm below the coil end, where the plasma has higher temperature. As presented in the figure, the radiation intensity can be modulated following the modulated coil current. This change in the radiation intensity means that the number of Ar excited atoms in the PMITP changed according to the coil current modulation. That response in radiation intensity from Ar-N₂ or Ar-CO₂ PMITP is slower than that from Ar PMITP. This difference in response time indicates that addition of molecular gas makes it difficult for Ar thermal plasmas to recover from a low-temperature state to a high-temperature state in the PMITP.

3.5.2. Response of Ar Excitation Temperature in PMITP

Next, the time evolution in Ar excitation temperature was estimated to confirm effects of such a coil current modulation in the rectangular waveform on the temperature of thermal plasmas [16, 17]. The input power is 30 kW for 100%SCL, i.e. for non-modulation operation. The pressure in the torch is atmospheric pressure. The Ar gas flow rate is 100 slpm, and the additional gas flow rate is 2.5 slpm. The measurement point is that at 10 mm below the coil end, which is a high-temperature region in the plasma. The Ar excitation temperature was determined using the two-line method assuming a Boltzmann distribution for the population of excited atoms. The net radiation intensities of Ar atomic lines at 703 nm and 714 nm were obtained after subtracting the continuum intensity around 709 nm from the measured intensities at 703 and 714 nm for determination of the Ar excitation temperature. Fig. (8) portrays (a) the pulse control signal, (b) the time evolution in the Ar excitation temperature for Ar PMITP, (c) that for Ar-N₂ PMITP, and (d) that for Ar-CO₂ PMITP. These Ar excitation temperatures were also measured at 10 mm below the coil end. In the case of Ar PMITP, the Ar excitation temperature is only slightly changed by modulation of the coil current. On the other hand, in molecular gas seeded Ar PMITP, i.e. Ar-N₂ and Ar-CO₂ PMITP, the Ar excitation temperature can be changed markedly following the modulated coil current. Particularly, in Ar-CO₂ PMITP, the coil current modulation can change the Ar excitation temperature by 2000-8000 K depending on the shimmer current level (SCL).

Fig. (9) presents the maximum and minimum values of the Ar excitation temperature in a modulation cycle in Ar PMITP with a different molecular gas. As presented in diagram (a), the maximum temperature remains almost unchanged at about 17 000 K as the SCL is varied. On the other hand, the minimum value drops as the SCL is reduced,
which suggests that one can control only the minimum temperature at a fixed maximum temperature by varying the SCL or LCL at a fixed HCL. In particular, in the case of CO$_2$ inclusion, the minimum temperature drops to 8000 K, which is about half the maximum temperature of 16000 K at SCL=40%. That fact indicates that CO$_2$ produces more efficient cooling of the thermal plasma than the other gases described here.

4. APPLICATION OF AR-N$_2$ PMITP FOR SURFACE NITRIDATION

It is interesting to apply PMITP with controlled temperature and radical densities to material processing. To date, application of PMITP for surface modification processing has been attempted [21, 22]. Here, we introduce nitridation processing of the Ti metallic surface using Ar-N$_2$ PMITP.

4.1. Plasma Torch, Reaction Chamber, and Specimen Position for Nitridation Processing

For nitridation processing, a Ti specimen was irradiated by Ar-N$_2$ PMITP downstream of the plasma torch. Fig. (10) portrays a schematic diagram of the plasma torch, the reaction chamber, and the titanium specimen for nitridation processing. The plasma torch is identical to that depicted in Fig. (4). Downstream of this plasma torch, a water-cooled reaction chamber with a specimen holder is installed. The specimen holder holds a 15-mm-diameter, 5-mm-thick titanium specimen. The specimen was irradiated directly by an Ar-N$_2$ PMITP. The Ar-N$_2$ gas mixture was supplied as a sheath gas with a swirl along the interior of the inner quartz tube from the top of the plasma torch. The total gas flow rate was fixed at 100.0 slpm, where the unit ‘slpm’ is the standard liters per minute. The nitrogen gas flow rate $Q_{N_2}$ was set to a value of 2.0 or 4.0 slpm. Pressure inside the chamber was fixed to 30 kPa (230 Torr). The ‘on-time’ and ‘off-time’ were set respectively to 10 ms and 5 ms in this experiment. In the present work, we fixed the time-averaged input power to the MOSFET inverter power supply to the same value of 15 kW for any SCL condition. This fixed power control can be realized using a higher HCL and a lower LCL to the current amplitude in the non-modulation condition, as portrayed in Fig. (11). This fixed power condition enables us to compare results under the same electric input power cost.

Fig. (12) depicts the dynamic behavior of the tail part of the Ar-N$_2$ PMITP, as recorded using a high-speed video camera. The respective gas flow rates of Ar and N$_2$ are 98 and 2 slpm; and the shimer current level (SCL) is 40%. The time increment of the images in this figure is 1.0 ms. On the other hand, the exposure time for one frame by the high-speed video camera was set to 333 μs. In panel (2), the plasma tail is visible, extending from the upper side according to “on-time” operation. This plasma tail extends to
the specimen holder with rotation motion in panels (2)-(5). This rotation motion originates from a supplied swirl gas. The plasma tail goes to the upper side again in panels (5)-(6) in “off-time”. These motions are repeated periodically according to coil current modulation.

Fig. (12). Dynamic behavior of the plasma tail. The gas flow rate of Ar/N₂ is 98/2 slpm [22].

4.2. XRD Analysis of the Irradiated Specimen Surface

The specimen surface of Ti irradiated by an Ar-N₂ PMITP was analyzed using X-ray diffraction (XRD) to determine the effect of the current modulation on the specimen surface composition. Fig. (13) shows examples of XRD spectra for the specimen surface irradiated by Ar-N₂ PMITP. The Ar and N₂ gas flow rates were, respectively, 98 slpm and 2 slpm. In this study, hydrogen is not used, thereby simplifying the experimental condition. The irradiation time is 5 min for all cases. In general, the nitridation by thermal plasmas depends on the nitrogen atomic flux onto the surface and the surface temperature. In other words, higher nitrogen atomic flux and higher surface temperature promotes surface nitridation of metal. However, higher surface temperature provides higher thermal damage of the surface. As shown there, XRD spectra for TiN (1 1 1), TiN (1 0 1) and TiN (2 0 0) are apparent in the case of SCL=100%, i.e. the non-modulation case. The appearance of these spectra from TiN and no other spectra indicates that the surface nitridation is enough. However, at SCL=70%, the intensities of TiN (1 1 1) and TiN (2 0 0) decrease, whereas those of TiN (1 0 1) increases and the spectrum of Ti₂N (1 0 1) appears. The appearance of Ti₂N indicates that the surface nitridation is not satisfactory. At still lower SCL, i.e. SCL=40%, the XRD spectra again come to resemble that at SCL=100%, although the modulation condition (thus the surface temperature) is different. Consequently, the influence of the coil-current modulation affects the surface structure. As seen in later sections, the coil current modulation affects the surface composition. It is emphasized that the coil current modulation affects the surface structure. As seen in later sections, the coil current modulation affects the surface structure.

4.3. Modulation Effect on the Increased Number of Nitrogen Excited Atoms

The neutral nitrogen atomic density irradiating the specimen surface is important for surface nitridation processing using thermal plasmas. We measured the radiation intensity of the nitrogen atomic line at 746.8 nm to estimate the behavior of the nitrogen atomic density [21, 22]. The radiation intensity was observed at 200 mm below the coil end on the axis of the plasma torch. This observation position corresponds to the position just above the specimen surface in case of irradiation experiments. Fig. (14) shows the time evolution in the radiation intensity of the nitrogen atomic line from the Ar-N₂ PMITP for SCL of 100, 70, and 40%. The nitrogen gas flow rate Q_N₂ is 4.0 slpm. As shown there, the peak value of the radiation intensity increases with reducing SCL. This result indicates that the pulse modulation of the coil current increases the instantaneous density of the excited nitrogen atom in the observation region, i.e. near the specimen surface.

Fig. (13). XRD spectra for specimen surface irradiated by Ar-N₂ PMITP with different shimmer current levels [21, 22].

Fig. (14). Time evolutions in the radiation intensity of the nitrogen atomic line at 746 nm from Ar-N₂ PMITP [21, 22].

For surface nitridation processing, the time-averaged nitrogen density and the instantaneous value are crucial because some nitridation processes require a longer time than the millisecond pulse-modulation cycle. Fig. (15) shows the time-averaged radiation intensity of the nitrogen atomic
line as a function of SCL for $Q_N = 4.0$ slpm. As shown there, the time-averaged radiation intensity increases with decreasing SCL, which indicates that the time-averaged nitrogen density also increases with decreasing SCL.

Fig. (15). Time-averaged radiation intensity of the nitrogen atomic line at 746 nm from Ar-N$_2$ PMITP [21, 22].

For another on-time condition, we found such a more nitrogen-excited atom in time-averaged value in modulation operation compared with that in non-modulation operation [23]. Fig. (16) presents the time-averaged radiation intensity of the nitrogen atomic line at 746.8 nm, as compared with the intensity in non-modulation operation for different on-times. Radiation intensity of the nitrogen atomic line at 746.8 nm for a non-modulated plasma was measured as the input power is increased. The results for the non-modulated plasma are plotted with squares in figure 16. On the other hand, for a modulated plasma, the time-averaged radiation intensity of the nitrogen atomic line at 746.8 nm in a modulation cycle was measured with fixed off-time of 5 ms and fixed HCL and LCL as the on-time is increased. In this case, the input power is also increased by increasing on-time. The results for modulated plasma with HCL=385 A and LCL=155 A are plotted with triangles. Similarly, the results for modulated plasma with HCL=355 A and LCL=155 A are plotted with circles. Note that the horizontal axis in figure 16 is the input power. As shown in this figure, a higher intensity is apparent at 15-22 kW in modulation operation than that in non-modulation operation.

Fig. (16). Time-averaged radiation intensity of the nitrogen atomic line at 746 nm from Ar-N$_2$ PMITP for different on-time. Input power is changed by changing the on-time [23].

4.4. Modulation Effect on the Decreased Specimen Surface Temperature

The specimen’s surface temperature is also a principal factor for nitridation and thermal damage. Fig. (17) depicts the time variation in the surface temperature of titanium specimens for different SCL cases. The Ar-N$_2$ PMITP was irradiated from $t=0$ s in this figure. After irradiation of the Ar-N$_2$ PMITP, the surface temperature increases with time. The surface temperature is almost saturated at about 100 s after irradiation. The irradiation of the Ar-N$_2$ PMITP was stopped at $t=150$ s. After irradiation of the Ar-N$_2$ PMITP, the surface temperature decreases rapidly with time. It is noteworthy that the surface temperature variation depends on the SCL, although the input power to the inverter power supply is the same value of 15 kW for all cases. From simple analysis of energy balance equation for specimen, results show that the net enthalpy flow on the specimen was decreased by reduction of SCL [22].

Fig. (17). Temperature variation in surface of specimen irradiated by Ar-N$_2$ PMITP.

Reducing the SCL increases the excited nitrogen atomic density simultaneously, as described in the previous section. Consequently, reducing SCL, i.e. the modulation of the coil-current simultaneously causes both an increase in the excited nitrogen atomic density and a decrease in the net enthalpy flow.

4.5. Numerical Simulation Considering Non-equilibrium Effects

The phenomena described above including the increased nitrogen excited atoms and the simultaneously obtained decreased enthalpy flow were unobtainable through analyses of the basis of the local thermodynamic equilibrium condition because more nitrogen excited atoms are obtained by increasing the temperature. To confirm this phenomenon, we developed a two-dimensional, two-temperature chemically non-equilibrium (2D-2TNCE) model of the Ar-N$_2$ PMITP [24-26]. This model solves a set of mass conservation equations of a bulk plasma, momentum conservation equations, an energy conservation equation for electrons, an energy conservation equation for heavy particles, a mass conservation equation of each species, and a Maxwell equation for the vector potential with the help of the equation of state and the equation of charge neutrality. The set of the governing equations is presented in Table 2.

Fig. (18) shows the time evolution in the spatial distribution of electron temperature $T_e$ and heavy particle temperature $T_h$ in Ar-N$_2$ PMITP after a rapid increase in the coil current from LCL to HCL. The shimmer current level is 40% and the Ar/N$_2$ gas flow rate is 98/2 slpm. In the reaction chamber, $T_e$ is close to $T_h$. However, in the plasma torch, especially near the torch wall, $T_e$ is apparently increased more rapidly than $T_h$. Therefore, pulse modulation of the coil current thermally enhances non-equilibrium effects near the torch wall.

Fig. (18). Time evolution in the spatial distribution of electron temperature $T_e$ and heavy particle temperature $T_h$ in Ar-N$_2$ PMITP.
Table 2. Governing Equations for a Two-temperature Chemically Non-equilibrium Model.

Mass conservation:
\[
\frac{\partial \rho}{\partial t} + \frac{\partial (\rho u_j)}{\partial x_j} + \frac{\partial (\rho v_{ij})}{\partial y_j} = 0
\]  
\[\text{(1)}\]

Momentum conservation:
\[
\frac{\partial (\rho u_j)}{\partial t} + \frac{\partial (\rho u_j u_j)}{\partial x_j} = \frac{\partial p}{\partial x_j} + \frac{\partial}{\partial x_j} \left( \mu \frac{\partial u_j}{\partial y_j} \right) + \frac{\partial}{\partial y_j} \left( \mu \frac{\partial u_j}{\partial x_j} \right) - \frac{\partial \mu}{\partial x_j} \frac{\partial \tau_{ij}}{\partial y_j} + \frac{\partial}{\partial y_j} \left( \mu \frac{\partial v_{ij}}{\partial x_j} \right) + \frac{\partial}{\partial x_j} \left( \mu \frac{\partial v_{ij}}{\partial y_j} \right)
\]  
\[\text{(2)}\]

Energy conservation:
\[
\frac{\partial (\rho e_j)}{\partial t} + \frac{\partial (\rho e_j u_j)}{\partial x_j} + \frac{\partial (\rho e_j v_{ij})}{\partial y_j} = \frac{\partial (\rho i_{ij})}{\partial x_j} + \frac{\partial (\rho i_{ij} v_{ij})}{\partial y_j} - \frac{\partial (\rho Q_{ij})}{\partial y_j} - \frac{\partial (\rho W_{ij})}{\partial y_j}
\]  
\[\text{(3)}\]

Translational energy conservation of electron:
\[
\frac{\partial (\rho e_{j,1})}{\partial t} + \frac{\partial (\rho e_{j,1} u_j)}{\partial x_j} + \frac{\partial (\rho e_{j,1} v_{ij})}{\partial y_j} = \frac{\partial (\rho i_{1,1})}{\partial x_j} + \frac{\partial (\rho i_{1,1} v_{ij})}{\partial y_j} + \frac{\partial (\rho Q_{1,1})}{\partial y_j} - \frac{\partial (\rho W_{1,1})}{\partial y_j}
\]  
\[\text{(4)}\]

Mass conservation of species j:
\[
\frac{\partial (\rho n_j)}{\partial t} + \frac{\partial (\rho n_j u_j)}{\partial x_j} + \frac{\partial (\rho n_j v_{ij})}{\partial y_j} = \frac{\partial (\rho Y_{i,j})}{\partial x_j} + \frac{\partial (\rho Y_{i,j} v_{ij})}{\partial y_j}
\]
\[\text{(5)}\]

Translational thermal conductivity of heavy particle:
\[\chi_0 = \frac{15}{4} \sum_{j=1}^{\infty} n_j \sum_{\ell=1}^{\infty} \xi_{\ell j} \rho_{\ell j} T_{\ell j} \]  
\[\text{(6)}\]

Relations between mass density and mass fraction:
\[n_j = \frac{\rho Y_{i,j}}{m_j} \]  
\[\text{(7)}\]

Equation of state:
\[p = \frac{Y_j}{m_e} r_{T_e} + \sum_{j=1}^{\infty} \frac{Y_j}{m_j} r_{T_j} \]  
\[\text{(8)}\]

Quasi-neutrality:
\[\eta = \sum_{j=1}^{\infty} \frac{n_j}{n_{\text{positive-charge}}} \]  
\[\text{(9)}\]

Balance of mass fraction:
\[\sum_{j=1}^{\infty} Y_j = 1 \]  
\[\text{(10)}\]

Effective diffusion coefficient of heavy particle:
\[D_{ij} = \frac{1}{1 - Y_j} \sum_{k, r} k_i D_{ij} \]  
\[\text{(11)}\]

Electrical conductivity:
\[\sigma = \frac{e^2}{kT_e} \sum_{j=1}^{\infty} n_j \rho_{ij} \]  
\[\text{(12)}\]

Viscosity:
\[\eta = \sum_{j=1}^{\infty} n_j \eta_{ij} \]  
\[\text{(13)}\]

Translational thermal conductivity of heavy particle:
\[\chi_0 = \frac{15}{4} \sum_{j=1}^{\infty} \sum_{\ell=1}^{\infty} \xi_{\ell j} \rho_{\ell j} T_{\ell j} \]  
\[\text{(14)}\]

Translational thermal conductivity of electron:
\[\chi_{e,0} = \frac{15}{4} \sum_{j=1}^{\infty} \eta_{\ell j} \rho_{\ell j} T_{\ell j} \]  
\[\text{(15)}\]

where \(r\): radius (m), \(v\): axial flow velocity (m/s), \(u\): axial flow velocity (m/s), \(p\): pressure (Pa), \(\rho\): density (kg/m^3), \(\mu\): viscosity (Pa*s), \(\beta\): whole enthalpy of heavy particle (kJ/kg), \(b\): enthalpy of species j (kJ/kg), \(K\): heavy particle temperature (K), \(T_e\): electron temperature (K), \(b_{\ell j}, b_{\ell j}^T\): translational thermal conductivity of heavy particle and electron, respectively (W/m²K), \(\sigma\): electrical conductivity (S/m), \(P_{\text{rad}}\): radiation loss (W/m³), \(D_{ij}\): effective diffusion coefficient of heavy particle (m²/s), \(n_j\): number density of species j (m⁻³), \(Y_j\): mass fraction of species j, \(\xi_j\): mole fraction of species j, \(m_j\): mass of species j (kg), \(T_{\ell j}\): radial and axial electron flux due to ambipolar diffusion (m/s²), \(a_{\ell j}, b_{\ell j}, c_{\ell j}\): rate coefficients of forward and backward reaction \(\ell\), respectively, \(\phi_{\text{rad}}\): Stefan-Boltzmann permeability of vacuum (W/m²K), \(e\): Boltzmann constant (J/K), \(A_{\ell j}\): vector potential (V/m), \(\omega\): angular frequency of coil current (rad/s), \(E_{\ell j}\): electric field strength (V/m), \(H_{\ell j}\): axial magnetic field strength (A/m), \(B_{\ell j}\): radial magnetic field strength (A/m), \(i\): complex index (i² = -1), \(\phi_{\text{rad}}\): reaction heat for reaction \(\ell\) (J), \(\Delta Q_{\ell j}\): reaction heat per unit volume and time (W/m³), \(\zeta_j\): momentum transfer collision integrals (m²), \(\tau_{\ell j}^{(1)}, \tau_{\ell j}^{(2)}, \tau_{\ell j}^{(3)}\): viscosity collision integrals (m²), \(v_j\): relative average velocity between electron and heavy particles (m/s), \(N_j\): total number of species, \(L_j\): total number of reactions, \(E_{\ell j}\): energy transfer between electron and heavy particles (W/m³), \(\delta[M]\) indicates the real part of a complex \(M\).
Fig. (18). Transient distribution in electron temperature $T_e$ and heavy particle temperature $T_h$ in Ar-N$_2$ PMITP.

Fig. (19) (a) presents the calculated time-averaged mass flow of nitrogen atoms from the Ar-N$_2$ PMITP into the specimen position by decreasing SCL. The nitrogen gas flow rate is 4 slpm. As portrayed in this figure, the time-averaged mass flow of nitrogen atoms increases concomitantly with decreasing SCL from 100% to 40%, meaning that the numerical simulation of Ar-N$_2$ PMITP also indicates an increase in mass flow of nitrogen atoms onto the specimen surface position. On the other hand, Fig. (19) (b) portrays the calculated time-averaged enthalpy flow from the Ar-N$_2$ PMITP into the specimen surface position. This figure portrays that a reduction of the SCL from 100% to 40% decreases the time-averaged enthalpy flow. Consequently, the numerical simulation also supports the fact that the modulation of the coil current produces such an increase in the mass flow of nitrogen atoms and a decrease in enthalpy flow simultaneously, which is also obtained in the experiments. This may be attributed to the following fact: In a modulated plasma, the time-averaged high-temperature region above about 7000 K in the plasma becomes larger than that in a non-modulated plasma since the high-temperature region is more shrunk in the non-modulated plasma. Thus, more power seems to be consumed for dissociation of nitrogen molecules in the modulated plasma than in the non-modulated plasma, which produces the higher mass flow of the nitrogen atom and their lower enthalpy flow. However, the effect of the coil current modulation is much greater in the experiment than that predicted by the numerical simulation for increased nitrogen atomic flux. This discrepancy between the experimental and simulation results may be due to the fact that this numerical simulation model considers only 30 reactions in the plasma, neglecting reactions producing nitrogen atom from excited nitrogen molecules, for example.

Fig. (19). Calculated time-averaged nitrogen atomic mass flow and enthalpy flow onto the surface position of the specimen.

5. APPLICATION OF AR-H$_2$ PMITP TO SURFACE MODIFICATION OF SPECIMENS

5.1. Application to TiO$_2$ Specimen [18]

Ishigaki et al. performed an experiment to apply Ar-H$_2$ PMITP to surface modification of TiO$_2$. The titanium dioxide (TiO$_2$) specimen was irradiated by Ar-H$_2$ PMITP at 26.6 kPa to obtain effects of PMITP irradiation. The characteristics of TiO$_2$ depend strongly on the formation of lattice defects and the incorporation of hydrogen.

Fig. (20) shows XRD spectra from the TiO$_2$ disk specimen treated in the plasma with and without the coil current modulation at a pressure of 26.6 kPa. The parameter in this figure is the specified position, whose details are apparent in Ref. [18]. As the number of the position parameters in this figure increases from 100 to 200, in millimeter, the distance between the plasma flame and the specimen surface decreases.
Fig. (20). XRD spectra from TiO$_2$ disks placed at various positions in Ar-H$_2$ plasma at a pressure of 26.6 kPa [18].

As this figure shows, the phases of all specimens remain unchanged, except for specimen placed in the plasma of continuous mode at a position parameter of 200. However, Fig. (20) (a) portrays that Magneli phases, Ti$_{2n+1}$O$_2$, were formed on the surface of the specimen at a position parameter of 200. The disk specimen, treated at position of 200 under 26 kPa in the continuous plasma, was irradiated directly by the plasma flame; then the surface was heated to a temperature that was higher than that of the remaining specimens. Consequently, the specimen was highly reduced from TiO$_2$ to Ti$_{2n+1}$O$_2$.

However, as presented in Fig. (20) (b), XRD spectra from Magneli phases Ti$_{2n+1}$O$_2$ were not observed. An important point is that the specimens treated in the PMITP were not reduced, even at the highest position of 200, where the specimen temperature is higher than that of the remaining samples and the concentration of hydrogen atoms is presumed to be the highest of all three sample positions. Ishigaki et al. suggested that this difference in the results described above between the irradiation of PMITP and the continuous plasma might be attributed to non-equilibrium effects in the PMITP.

5.2. Application to H Doping onto a ZnO Specimen [19, 20]

Following is an example of adoption of PMITP to hydrogen atom doping to ZnO. Many recent investigations of zinc oxide (ZnO) have reported its quantum effect in superlattices, laser emission, and heterojunction light emitting diode. Consequently, the control of defects related to electron-hole recombination processing is important to improve the ZnO emission efficiency. Hydrogen plasma irradiation has been indicated as suitable for passivation of ZnO radiative recombination centers giving visible emission (VIS) at 2.3 eV. However, a conventional heating technique in a H$_2$ gas to dope hydrogen atom into ZnO causes the formation of defects such as oxygen vacancy or evaporation of ZnO. Furthermore, ZnO was reduced through continuous irradiation with non-modulated hydrogen plasma.

Ohashi et al. applied Ar-H$_2$ PMITP for this purpose [19, 20]. Use of the ArH$_2$ PMITP provides less heat accumulation in the irradiation specimen than with the continuous plasma irradiation. Experimental conditions were as described below. They used on-time of 10 ms and off-time of 5 ms. The rf frequency was 1 MHz, the input power level to an inverter power supply is 13 kW for a higher level, although it is 4 kW for a lower level. The hydrogen gas flow rate was set to $6 \times 10^{-3}$ m$^3$/min, whereas the Ar gas flow rate was 98 $\times 10^{-3}$ m$^3$/min. The total gas pressure was 27 kPa. The irradiation time was 300 s. Details of the experimental setup are available in an earlier report [18].

Ohashi et al. confirmed in their experiments that Ar-H$_2$ PMITP irradiation does not reduce ZnO, although a non-modulated plasma irradiation does. Additionally, they found that improvement of photoluminescence of ZnO was achieved by irradiation of ArH$_2$ PMITP. Fig. (21) shows the photoluminescence (PL) spectra of ZnO. For original polycrystalline ZnO, a broad VIS emission band was detected around 2.3 eV, and an ultraviolet (UV) emission band at 3.3 eV. After irradiation of Ar-H$_2$ PMITP, as portrayed in Fig. 21, the VIS emission band disappeared and the UV emission intensity increased by more than 10 times. Improvement in UV emission efficiency can be ascribed to the passivation of active centers, which are the origin of the VIS emission.

Fig. (21). Typical photoluminescence spectra of ZnO before and after hydrogen plasma irradiation for Polycrystalline ceramic [20].

6. APPLICATIONS OF AR-O$_2$ PMITP FOR NANOPowDER SYNTHESIS

In the previous section, we found that heat flux and mass flux of atomic particles downstream of the plasma torch can be controlled by the modulated coil current. This feature might be adopted for controlling nanoparticle synthesis if the modulated induction thermal plasma is used. We are now trying to apply the Ar-O$_2$ PMITP to TiO$_2$ nanopowder synthesis to study the effect of current modulation on the synthesized nanopowder. This is the latest result on PMITP application. A plasma torch with the same configuration to that in the previous section was also used in this work. However, downstream of the torch, a vertical reaction chamber, a horizontal reaction chamber and a filter
were installed for nanopowder synthesis. The Ar/O₂ gas flow rate was 90/10 slpm. Titanium powder with a mean diameter of 45 μm was fed with Ar carrier gas with a water-cooled probe inserted from the top-center of the plasma torch to the plasma. The powder feed rate was set around 3.5-4 g/min. The pressure was fixed at 300 Torr. Injected raw titanium powder is vaporized in the thermal plasma, and TiO₂ nanoparticles is nucleated from the titanium vapor and oxygen atom in the reaction chamber installed downstream of the plasma torch [6]. The time-averaged input power was fixed at 20 kW, irrespective of that with and without coil current modulation. For PMITP, the on-time and the off-time in the coil current modulation was set to 12/3 ms; the shimmer current level (SCL) is 65% in the modulation case, and 100% for the non-modulation case. Fig. (22) portrays the size distribution of synthesized particles by modulated induction plasmas at SCL=65% and 100%. From this figure, results show that the particles synthesized by the PMITP at SCL=65% have a smaller mean-diameter and a smaller standard deviation than those by the non-modulated plasma at SCL=100%.

7. DEVELOPMENT OF ARBITRARY WAVEFORM MODULATED INDUCTION THERMAL PLASMA

7.1. Concept and Electric Circuit for AMITP

Recently, we developed a new type of modulated induction thermal plasma system: it is a system of an arbitrary-waveform modulated induction thermal plasma (AMITP) [27]. This system can modulate the coil current sustaining an induction thermal plasma not only into a rectangular waveform but also into an externally determined waveform in milliseconds. Fig. (23) depicts an example of the coil current for AMITP. The coil current amplitude is modulated following an externally given waveform, which is changed in milliseconds.

To realize AMITP, we have developed a new rf power supply which has IGBT and MOSFET elements. Fig. (24) shows the electric circuit for AMITP. The modulation in this case is achieved by switching IGBT. On the other hand, in this power supply, MOSFET elements are switched with a frequency to synchronize a frequency changed by a plasma load using phase-locked loop (PLL) control.

7.2. Dynamic Behavior of Ar AMITP

Fig. (25) shows (a) the modulation signal, (b) the inverter output current in root-meansquare value, (c) the radiation intensity of the Ar atomic line at 703 nm, and (d) the Ar excitation temperature, in a triangular-rectangular waveform modulation case [27]. The input power is 10 kW, and the pressure is 5.3 kPa (=40 Torr). The observation was conducted at 10 mm below the coil end. The observed radiation intensity changes periodically in a triangular waveform according to the modulation control signals with some delay compared to the modulation signal. The delay time was estimated roughly as 5 ms because of the time difference between the minimum of the coil current amplitude and the minimum of the radiation intensity. This delay time in the radiation intensity arises mainly from the thermal inertia of thermal plasmas, which is governed mainly by the mass density and specific heat of high-temperature Ar gas. Fig (25) (c) depicts the variation of the radiation intensity for the triangle-rectangular waveform. Results show that the radiation intensity for the rectangular part becomes higher than that for the first triangular part, which arises from the accumulated power inputted to the plasma.

It is interesting to see how the temperature changes following the modulation signal. The Ar excitation temperature was estimated using the two-line method with the two specified Ar lines at 703 and 714 nm. Fig. (25) (d) shows the time evolution in the Ar excitation temperature in the case of triangular-rectangular waveform modulation [27].
PMITP. The modulated thermal plasma is a promising control of the temperature is possible in AMITP than has been developed. Results demonstrate that more detailed new type of modulated induction thermal plasma, AMITP, nanopowder synthesis using thermal plasmas. In addition, a control the nanopowder size if the PMITP is used for Results also show that the coil current modulation can fundamental dynamic behaviors of PMITPs, in addition to applications of PMITPs. Results show that the modulation of the coil current can perturb high-pressure high-power thermal plasmas, and can control the temperature and radical densities. Especially, Ar excitation temperature in a molecular gas seeded Ar thermal plasma can be changed following the modulated coil current. Application of PMITP to surface modification processing is one candidate for use of chemically non-equilibrium effects occurring in PMITPs. Results also show that the coil current modulation can control the nanopowder size if the PMITP is used for nanopowder synthesis using thermal plasmas. In addition, a new type of modulated induction thermal plasma, AMITP, has been developed. Results demonstrate that more detailed control of the temperature is possible in AMITP than PMITP. The modulated thermal plasma is a promising radical and heat source for use in high-speed material processing.

REFERENCES


